

## PRODUCT SUMMARY

V <sub>DS</sub> (V)	- 40
$R_{DS(on)} (\Omega)$ at $V_{GS}$ = - 10 V	0.0094
$R_{DS(on)}(\Omega)$ at $V_{GS}$ = - 4.5 V	0.0160
I <sub>D</sub> (A)	- 90
Configuration	Single

# TO-252 G D S Top View P-Channel MOSFET

#### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- Package with Low Thermal Resistance
- 100 %  $R_{\rm q}$  and UIS Tested
- AEC-Q101 Qualified<sup>d</sup>
- Material categorization: For definitions of compliance please see www.freescale.net.cn



ORDERING INFORMATION		
Package	TO-252	
Lead (Pb)-free and Halogen-free	SQD90P04-9m4L-GE3	

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \degree C$ , unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V <sub>DS</sub>	- 40	N	
Gate-Source Voltage		V <sub>GS</sub> ± 20		- V	
Continuous Drain Current <sup>a</sup>	T <sub>C</sub> = 25 °C	1	- 90		
	T <sub>C</sub> = 125 °C	I <sub>D</sub>	- 52		
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	- 100	A	
Pulsed Drain Current <sup>b</sup>		I <sub>DM</sub>	- 160		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	- 50		
Single Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	125	mJ	
Maximum Power Dissipation <sup>b</sup>	T <sub>C</sub> = 25 °C	D	136	W	
	T <sub>C</sub> = 125 °C	P <sub>D</sub>	45	vv	
Operating Junction and Storage Temperature Ra	inge	T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount <sup>c</sup>	R <sub>thJA</sub>	50	°C/W	
Junction-to-Case (Drain)	p-Case (Drain)		1.1	C/W	

#### Notes

- a. Package limited.
- b. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%.$
- c. When mounted on 1" square PCB (FR-4 material).

d. Parametric verification ongoing.



<b>SPECIFICATIONS</b> ( $T_c = 25$ °C, unless otherwise noted)								
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	·	- -						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$		- 40	-	-	V	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	V <sub>GS</sub> , I <sub>D</sub> = - 250 μA	- 1.5	-	- 2.5	v	
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	± 100	nA	
		$V_{GS} = 0 V$	V <sub>DS</sub> = - 40 V	I	-	- 1	μA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V$	$V_{DS}$ = - 40 V, $T_J$ = 125 °C	-	-	- 50		
		$V_{GS} = 0 V$	$V_{DS}$ = - 40 V, $T_J$ = 175 °C	-	-	- 150		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{GS} = -10 V$	$V_{DS} \le$ - 5 V	- 50	-	-	А	
		$V_{GS} = -10 V$	I <sub>D</sub> = - 17 A	-	0.0075	0.0094	Ω	
Drain-Source On-State Resistance <sup>a</sup>	P	$V_{GS} = -10 V$	$I_D = -50 \text{ A}, \text{ T}_J = 125 ^\circ\text{C}$	-	-	0.0147		
	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V	I <sub>D</sub> = - 50 A, T <sub>J</sub> = 175 °C	-	-	0.0178		
		$V_{GS} = -4.5 V$	I <sub>D</sub> = - 14 A	-	0.0130	0.0160		
Forward Transconductanceb	9 <sub>fs</sub>	V <sub>DS</sub> =	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 17 A		46	-	S	
Dynamic <sup>b</sup>	·	- -						
Input Capacitance	C <sub>iss</sub>		V <sub>DS</sub> = - 20 V, f = 1 MHz	-	5339	6675	pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$		-	852	1065		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	681	855		
Total Gate Charge <sup>c</sup>	Qg		V <sub>DS</sub> = - 20 V, I <sub>D</sub> = - 50 A	-	103	155	nC	
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>GS</sub> = - 10 V		-	15	-		
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>	1		-	21	-		
Gate Resistance	Rg	f = 1 MHz		1.4	2.8	4.2	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>				13	20	- ns	
Rise Time <sup>c</sup>	t <sub>r</sub>	$\begin{array}{l} V_{\text{DD}}=\text{-}~20~\text{V},~R_{\text{L}}=0.4~\Omega\\ I_{\text{D}}\cong\text{-}~50~\text{A},~V_{\text{GEN}}=\text{-}~10~\text{V},~R_{g}=1~\Omega \end{array}$		-	15	23		
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			-	61	92		
Fall Time <sup>c</sup>	t <sub>f</sub>			-	19	29		
Source-Drain Diode Ratings and Char	acteristics <sup>b</sup>				·			
Pulsed Current <sup>a</sup>	I <sub>SM</sub>			-	-	- 160	А	
Forward Voltage	V <sub>SD</sub>	I <sub>F</sub> = - 50 A, V <sub>GS</sub> = 0 V		-	- 0.95	- 1.5	V	

Notes

a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$ 

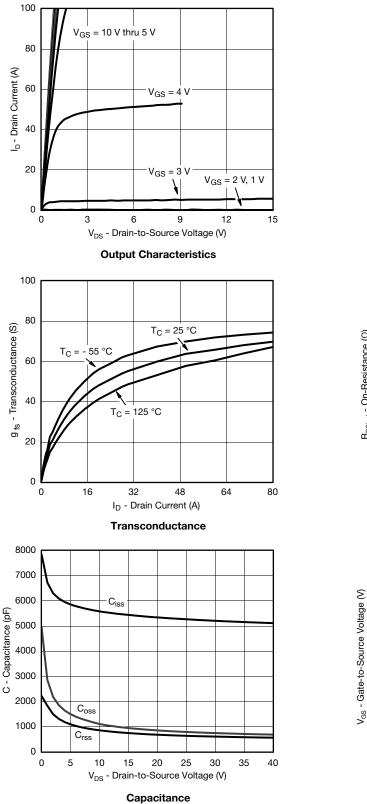
b. Guaranteed by design, not subject to production testing.

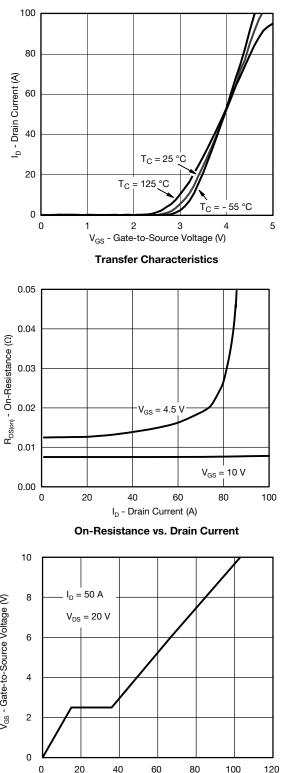
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



#### **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)

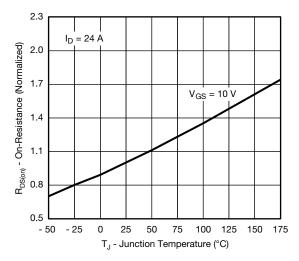




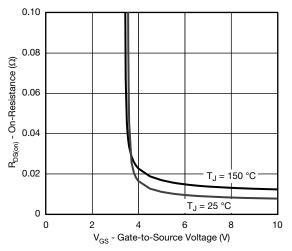
Q<sub>g</sub> - Total Gate Charge (nC) Gate Charge



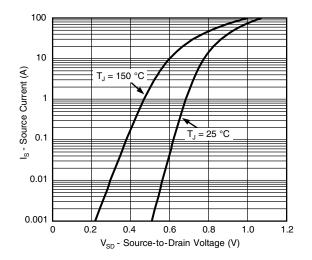
#### **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



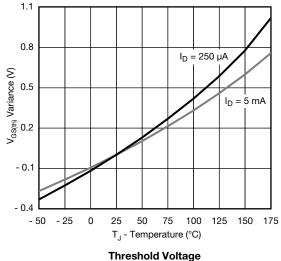
**On-Resistance vs. Junction Temperature** 



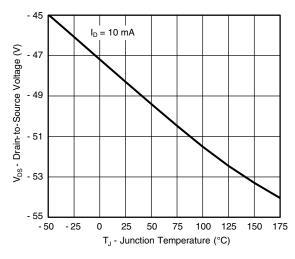
On-Resistance vs. Gate-to-Source Voltage



Source Drain Diode Forward Voltage



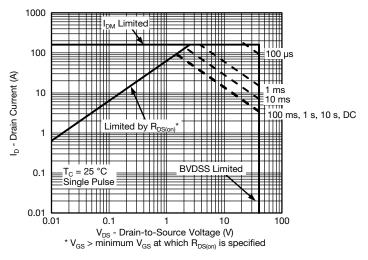




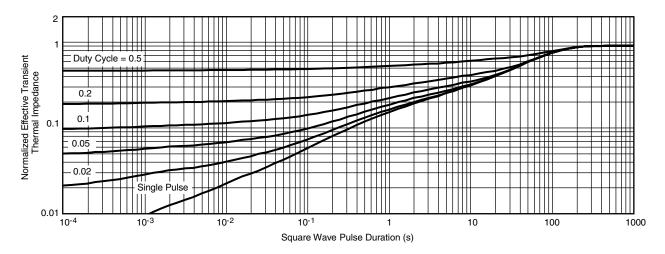
Drain Source Breakdown vs. Junction Temperature



#### **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



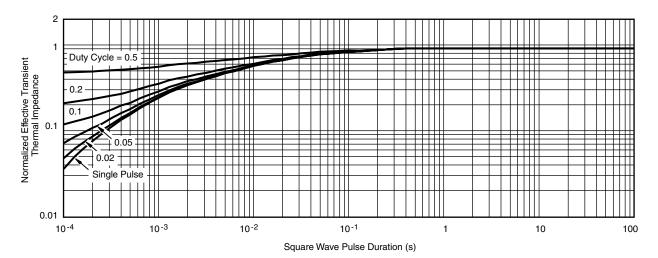
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



#### THERMAL RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



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